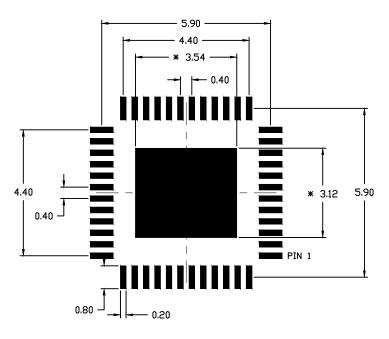
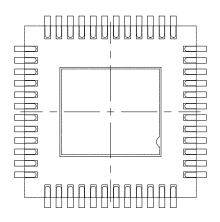
RECOMMENDED LAND PATTERN

PACKAGE OVERLAY





* THERMAL PAD IS NOT SQUARE

NUTES:

- 1. REFERENCE PKG, DUTLINE: 21-100232
- 2. LAND PATTERN COMPLIES TO: IPC7351A.
- 3. TOLERANCE: +/- 0.02 MM.
- 4. ALL DIMENSIONS APPLY TO PEFREE (+) PKG, CODES ONLY.
- 5. ALL DIMENSIONS IN MM.

-DRAWING NOT TO SCALE-

This document (including dimensions, notes & specs) is a recommendaton based on typical circuit board manufacturing parameters. Since land pattern design depend on many factors unknown to Maxim (eg. user's board manufacturing specs), user must determine suitability for use. This document is subject to change without notice.

Contact technical support at http://www.maxim-ic.com/support for further questions.



maxim integrated_™

TITLE:
PACKAGE LAND PATTERN, [F486A6F+1]
48L FCQFN, 6.0X6.0X0.90mm

APPROVAL DO

DOCUMENT CONTROL NO. 90-100077

REV.